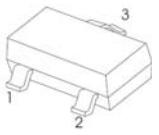


## UMW 2300N-Channel 20-V(D-S) MOSFET

<b>V<sub>(BR)DSS</sub></b>	<b>R<sub>DS(on)MAX</sub></b>	<b>I<sub>D</sub></b>	<b>SOT-23</b>
20V	25mΩ@4.5V	6A	 1. GATE 2. SOURCE 3. DRAIN
	34.5mΩ@2.5V		

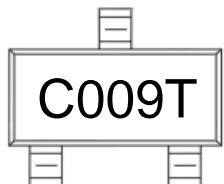
### FEATURE

- TrenchFET Power MOSFET

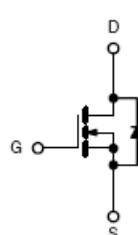
### APPLICATION

- Load Switch for Portable Devices
- DC/DC Converter

### MARKING



### Equivalent Circuit



**Maximum ratings (T<sub>a</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	20	V
Gate-Source Voltage	V <sub>GS</sub>	±12	
Continuous Drain Current	I <sub>D</sub>	6	A
Continuous Source-Drain Current(Diode Conduction)	I <sub>S</sub>	0.6	
Power Dissipation	P <sub>D</sub>		W
Thermal Resistance from Junction to Ambient (t≤5s)	R <sub>θJA</sub>	312.5	°C/W
Operating Junction	T <sub>J</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	

**T<sub>a</sub>=25 °C unless otherwise specified**

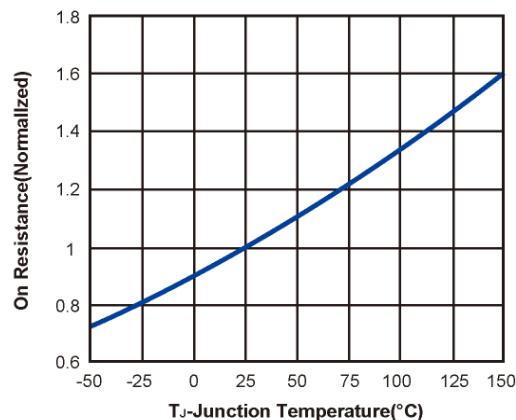
Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Static</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 10µA	20			V
Gate-threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 50µA	0.40		1	
Gate-body leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±8V			±100	nA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V			1	µA
Drain-source on-resistance <sup>a</sup>	R <sub>D(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 6A		0.021	0.025	Ω
		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 5.2A		0.028	0.034	
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 3.6A		8		S
Diode forward voltage	V <sub>SD</sub>	I <sub>S</sub> = 0.94A, V <sub>GS</sub> = 0V		0.74	1.2	V
<b>Dynamic</b>						
Total gate charge	Q <sub>g</sub>	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 3.6A		7.7	10	nC
Gate-source charge	Q <sub>gs</sub>			0.32		
Gate-drain charge	Q <sub>gd</sub>			2.1		
Input capacitance <sup>b</sup>	C <sub>iss</sub>	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1MHz		574		pF
Output capacitance <sup>b</sup>	C <sub>oss</sub>			70		
Reverse transfer capacitance <sup>b</sup>	C <sub>rss</sub>			60		
<b>Switching<sup>b</sup></b>						
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 10V, R <sub>L</sub> = 5.5Ω, I <sub>D</sub> ≈ 3.6A, V <sub>GEN</sub> = 4.5V, R <sub>g</sub> = 6Ω		78.7		ns
Rise time	t <sub>r</sub>			128		
Turn-off delay time	t <sub>d(off)</sub>			453		
Fall time	t <sub>f</sub>			80.9		

**Notes :**

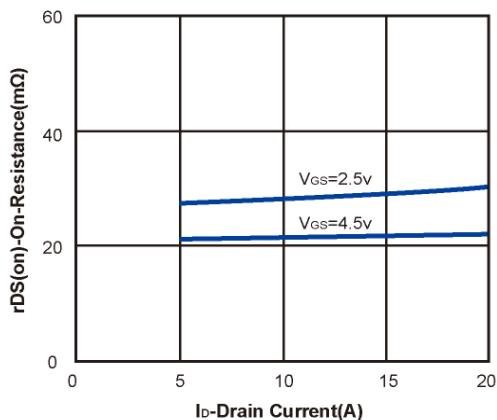
- a. Pulse Test : Pulse width ≤ 300µs, duty cycle ≤ 2%.
- b. These parameters have no way to verify.

### Typical Characteristics ( $T_J = 25^\circ\text{C}$ Noted)

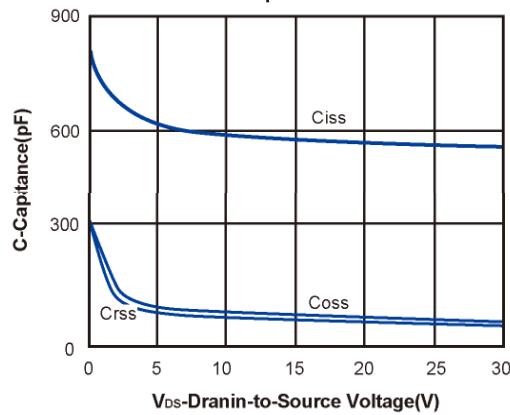
On Resistance vs. Junction Temperature



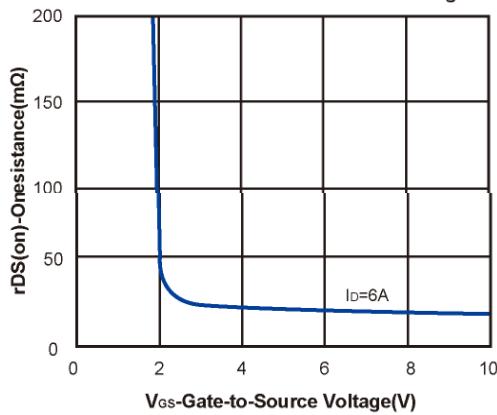
On Resistance vs. Drain Current



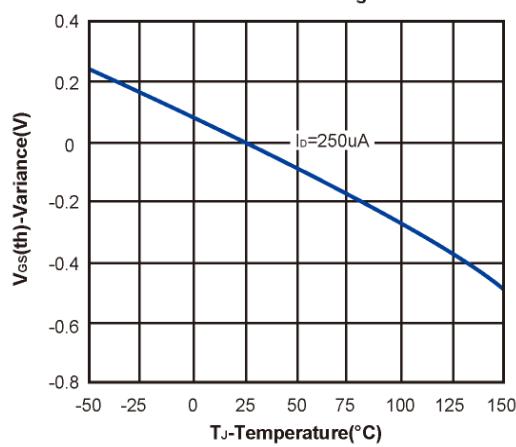
Capacitance



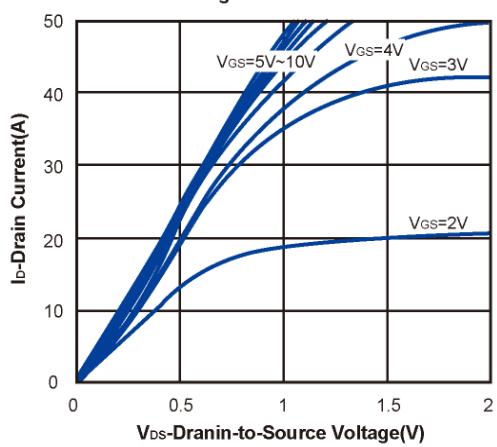
On Resistance vs. Gate-to-Source Voltage



Threshold Voltage



On-Region Characteristics



**Typical Characteristics ( $T_J = 25^\circ\text{C}$  Noted)**

